# LARS: LASER-ASSISTED RECYCLING OF SILICON SOLAR MODULES

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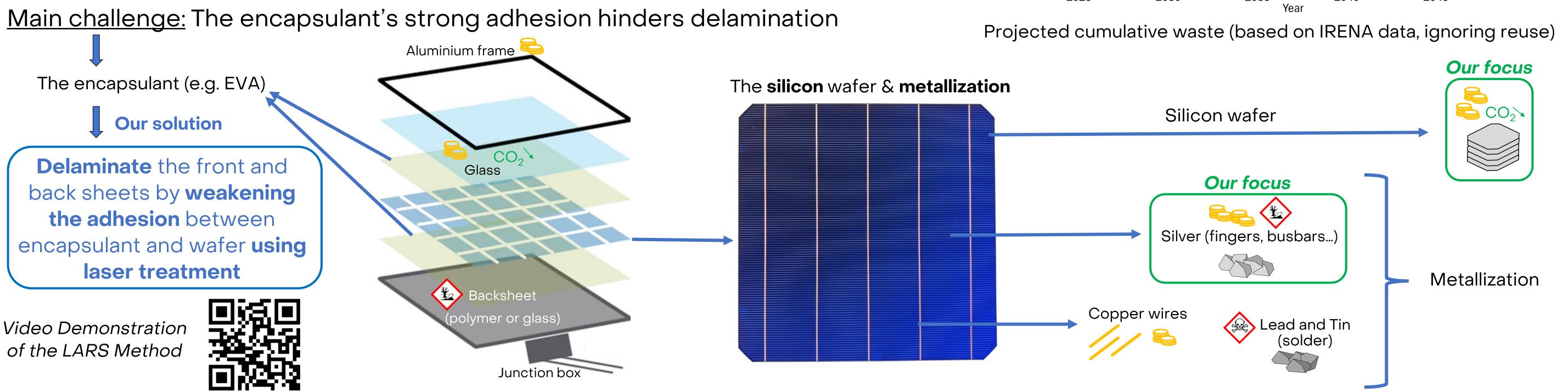
### INTRODUCTION

#### A need for PV recycling method

- A large increase of PV waste in the coming years (see graph)
- Access to high value materials (silver, high purity silicon with embedded energy) & toxic materials (PFAS & Lead):
  - Geopolitical independence
  - Environmental and financial benefits

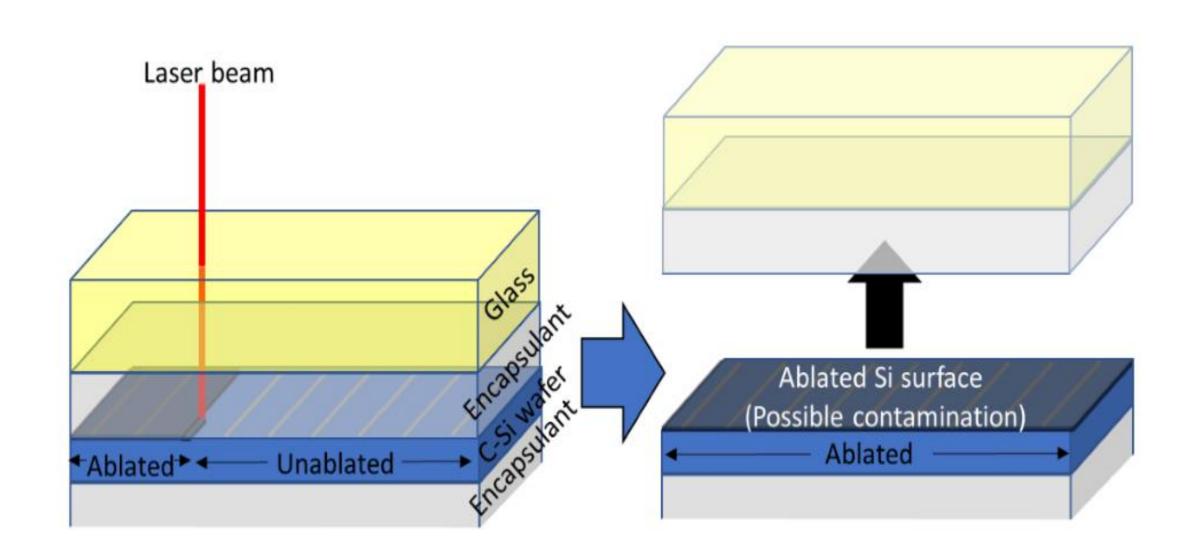
Develop an energy-efficient, versatile, sustainable and economically viable recycling method to access valuable and toxic materials in silicon solar modules

5.0E+09 Waste assuming 25y lifetime (world) 4.5E+09 - Waste assuming 25y lifetime (EU) Waste assuming 10y lifetime (world) 4.0E+09 - Waste assuming 10y lifetime (EU) 3.5E+09 을 3.0E+09 2.5E+09 2.0E+09 த் 1.5E+09 ₹ 1.0E+09 5.0E+08 0.0E+00 2030 2025

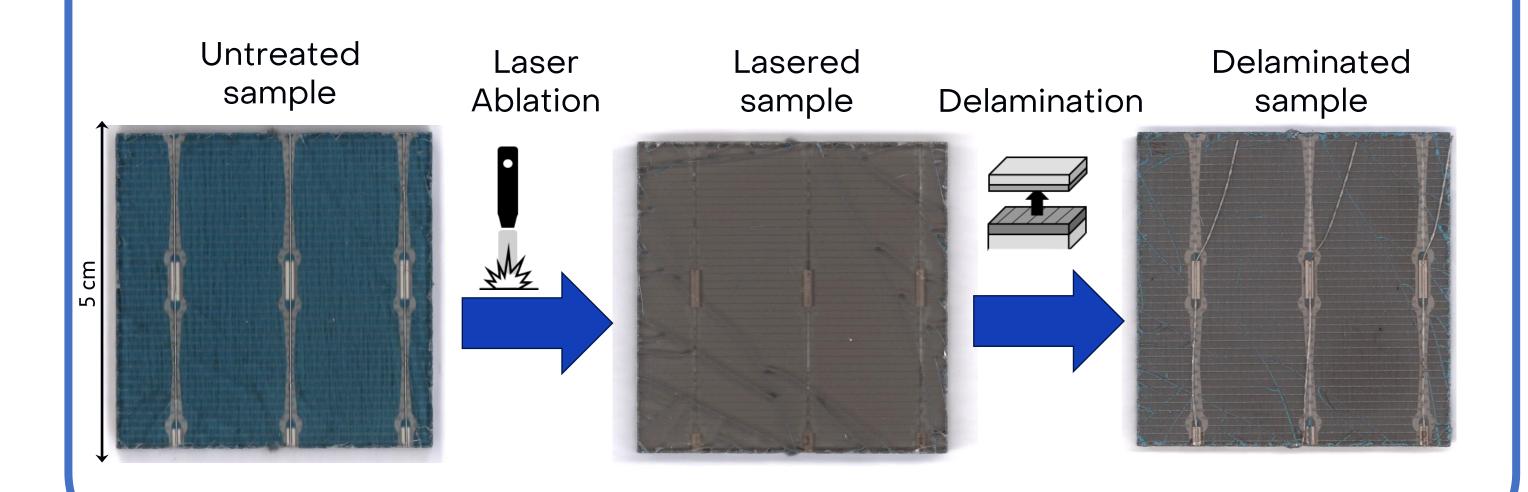


### LASER-SEPARATION

We use laser-ablation to achieve clean separation of the encapsulant and the silicon wafer. A pulsed laser (picosecond or nanosecond laser) selectively ablates the top surface of the silicon wafer, weakening the adhesion between the encapsulant and the wafer. A subsequent mechanical **separation step** allows access to the valuable materials.



This method is applied on 5x5 cm<sup>2</sup> samples cut by water-jet from commercial modules



### **RESULTS**

Ablation and easy-separation of commercial modules

- Energy-efficient with optimized lasering parameters (pulse duration, wavelength, frequency, focus, speed, patterning...) for low energy ablation and **easy separation**
- Versatile across different module types (PERC, Al-BSF, TOPCon) and can be tuned to industrial needs
- Enables **rear and front side** separation
- No silver loss was observed after the lasering process

#### Chemical cleaning step

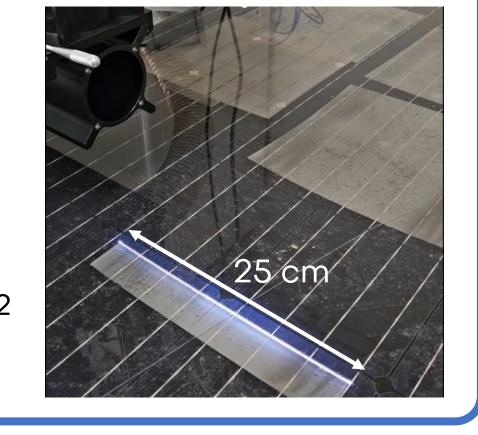
Clean wafer pieces Wafer pieces Chemical cleaning

- Recover silver and isolate toxic materials (lead, tin...) by chemical treatment (KOH, HNO<sub>3</sub>) under **mild conditions**
- Achieve **high-purity\*** and **high yield** silicon recovery with a purity exceeding 99,99% (4N)

\*analyzed by ICP-MS

## **UPSCALING**

Successfully switched from picosecond to industry-ready nanosecond pulsed laser ablation



Full-module laser treatment on a 25x25 cm<sup>2</sup> treated areas

# **CONCLUSION & OUTLOOK**

Laser Assisted Recycling of silicon Solar module proves to be a versatile, energy efficient and scalable process which allows the recovery of high-purity, scarce and valuable materials.

#### **Future work**

- Apply to cell technologies with a significantly different layer architecture, such as SHJ
- Optimize the mechanical separation step, especially for upscaling purposes
- Investigate the use of LARS recycled silicon for applications like batteries
- Optimise laser parameters for industrial application (throughput, OPEX)

# **CONTACT US**

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